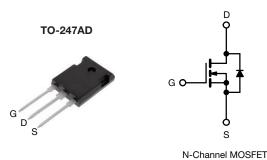
SiHW47N60EF



Vishay Siliconix

EF Series Power MOSFET with Fast Body Diode

PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	650)
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.065
Q _g max. (nC)	228	3
Q _{gs} (nC)	32	
Q _{gd} (nC)	62	
Configuration	Sing	le



FEATURES

- · Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Increased robustness due to low Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity lighting (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
- ATX power supplies
- Industrial - Welding
 - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switching mode power supplies (SMPS)
- · Applications using the following topologies
- LLC
- Phase shifted bridge (ZVS)
- 3-level inverter
- AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW47N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T_{C} :	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	600	V	
Gate-Source Voltage		V _{GS}	± 30	v	
Continuous Drain Current (T 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1	47	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	29	A
Pulsed Drain Current ^a	•		I _{DM}	138	
Linear Derating Factor				3	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	1500	mJ
Maximum Power Dissipation		PD	379	W	
Operating Junction and Storage Temperature Range	Э		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 1	125 °C		70	
Reverse Diode dV/dt ^d		dV/dt	50	V/ns	
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 73.5 mH, R_g = 25 Ω , I_{AS} = 6.4 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 500 A/µs, starting T_J = 25 °C

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THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.33	C/W

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-		•	•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μΑ	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-		-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = 250 μA	2.0	-	4.0	V
		, N	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	, v	V _{GS} = ± 30 V	-	-	± 1	μA
			480 V, V _{GS} = 0 V	-	-	1	· ·
Zero Gate Voltage Drain Current	I _{DSS}		, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 24 \text{ A}$	-	0.056	0.065	Ω
Forward Transconductance	g _{fs}	V _{DS}	= 30 V, I _D = 24 A	-	17	-	S
Dynamic					1	1	<u> </u>
Input Capacitance	C _{iss}	<u> </u>		-	5000	-	-
Output Capacitance	C _{oss}	- ,	V _{GS} = 0 V, V _{DS} = 100 V,		220	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	7	-	-
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	172	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{\rm DS} = 0.0$	/ to 480 V, V _{GS} = 0 V	-	634	-	
Total Gate Charge	Qg			-	152	228	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 24 \text{ A}, V_{DS} = 480 \text{ V}$	-	32	-	nC
Gate-Drain Charge	Q _{gd}			-	62	-	
Turn-On Delay Time	t _{d(on)}			-	30	60	
Rise Time	t _r	V _{DD} =	480 V, I _D = 24 A,	-	56	84	ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	= 10 V, $R_g = 4.4 \Omega$	-	91	137	115
Fall Time	t _f		1		56	84]
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.2	0.46	1.0	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol		-	47	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction		-	-	138	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 24 A, V _{GS} = 0 V	-	0.9	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			-	199	398	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_{\rm J} = 2$	$T_J = 25 \ ^{\circ}C, I_F = I_{S = 24 \ A},$		1.4	2.8	μC
Reverse Recovery Current	I _{RRM}	$dl/dt = 100 \text{ A}/\mu \text{s}, \text{V}_{\text{R}} = 400 \text{ V}$		_	13.2	_	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

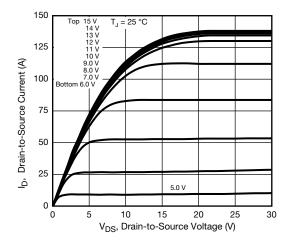


Fig. 1 - Typical Output Characteristics

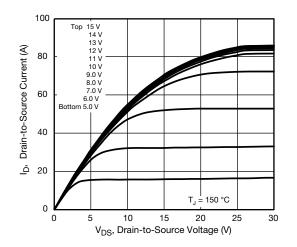
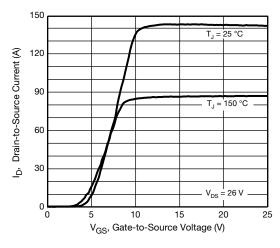


Fig. 2 - Typical Output Characteristics





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3.0 I_D = 24 A R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2.0 1.5 1.0 0.5 = 10 V V_{GS} 0.0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

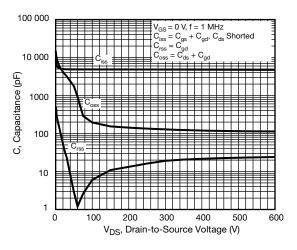


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

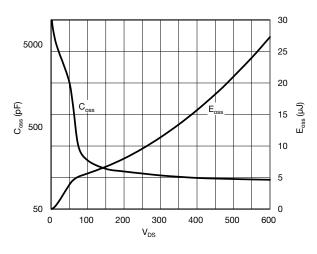


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

3 For technical questions, contact: <u>hvm@vishay.com</u>

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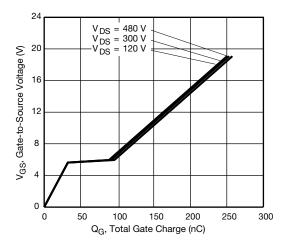


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

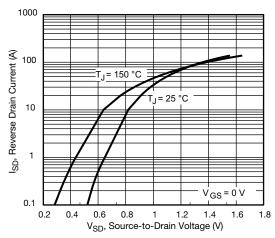


Fig. 8 - Typical Source-Drain Diode Forward Voltage

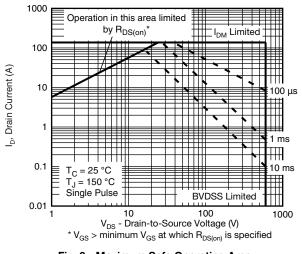


Fig. 9 - Maximum Safe Operating Area

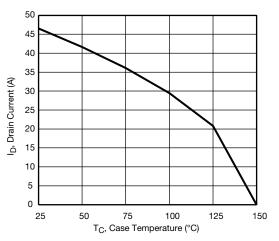


Fig. 10 - Maximum Drain Current vs. Case Temperature

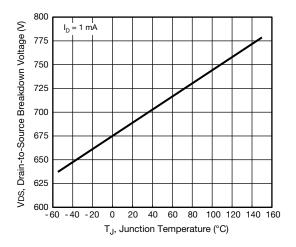
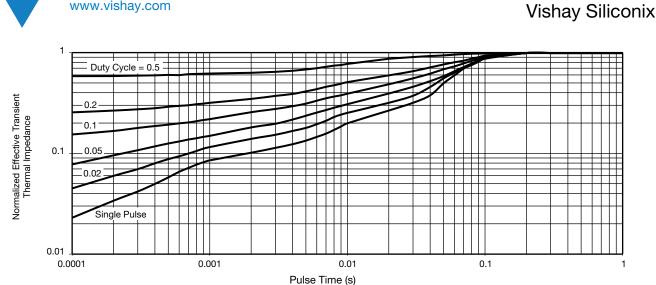
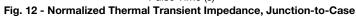
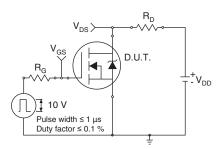


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

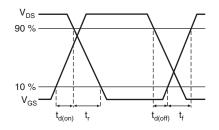


Fig. 14 - Switching Time Waveforms

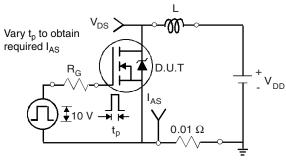


Fig. 15 - Unclamped Inductive Test Circuit

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V_{DS} V_{DD} V_{DS} I_{AS}

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Fig. 16 - Unclamped Inductive Waveforms

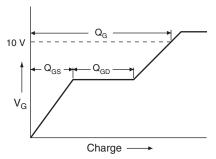


Fig. 17 - Basic Gate Charge Waveform

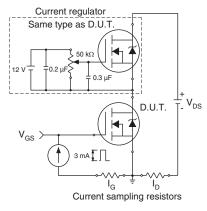


Fig. 18 - Gate Charge Test Circuit

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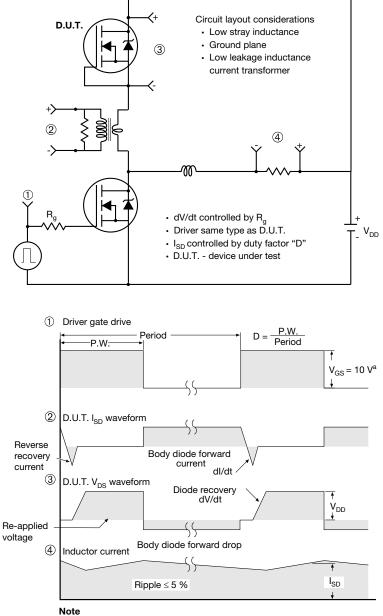
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

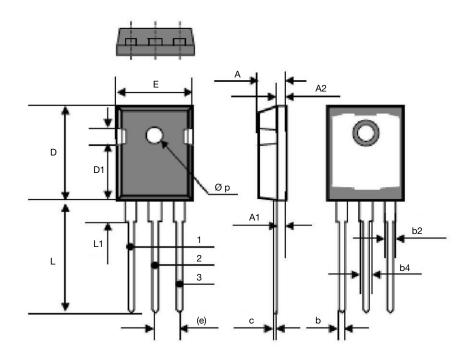
Fig. 18 - For N-Channel

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TO-247AD (High Voltage)



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61	BSC	0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46	BSC	0.215	BSC	
E	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øp	3.51	3.66	0.138	0.144	

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